PLT3 510

Metal Can® TO38

PLT3 510









Applications

- Health Monitoring (Heart Rate Monitoring, Pulse Oximetry)
- Projection Home LED & Laser
- Projection Professional LED & Laser

Features:

- Optical output power (continuous wave): 10 mW (T_c = 25°C)
- Typical emission wavelength: 520 nm
- Efficient radiation source for cw and pulsed operation
- Single tranverse mode semiconductor laser
- High modulation bandwidth
- Miniaturized TO38 ICut package
- Laser diode isolated against package

Ordering Information

Туре	Peak output power	Ordering Code	
	typ.		
	P_{opt}		
PLT3 510	10 mW	Q65112A4439	

Maximum Ratings

 $T_{\rm C}$ = 25 °C

Parameter	Symbol		Values
Operating temperature	T _{op}	min.	-20 °C
		max.	60 °C
Storage temperature	T_{stg}	min.	-40 °C
		max.	85 °C
Junction temperature	T_{j}	max.	120 °C
Forward current 1)	I _F	max.	120 mA
Reverse voltage 2)	V_{R}	max.	2 V
Soldering temperature	T _s	max.	260 °C
$t_{max} = 10 \mu s$			
Reverse voltage 3)	V_{R}		Not designed for
			reverse operation

Operation outside these conditions may damage the device. Operation at maximum ratings may influence lifetime.



Characteristics

 $P_{opt} = 10 \text{ mW}; T_A = 25^{\circ}\text{C}$

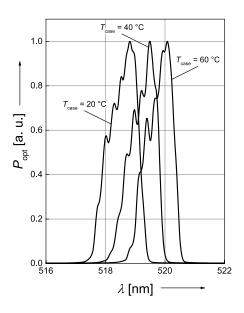
Parameter	Symbol		Values
Operating current 1)	I _{op}	typ. max.	55 mA 80 mA
Operating voltage 4)	V _{op}	typ. max.	5.0 V 6.6 V
Peak wavelength 5)	$\lambda_{ m peak}$	min. typ. max.	510 nm 520 nm 530 nm
Spectral bandwidth (FWHM)	Δλ	typ.	1 nm
Beam divergence (FWHM) parallel to pn-junction	$\Theta_{_{\parallel}}$	min. typ. max.	5 ° 7 ° 9 °
Beam divergence (FWHM) perpendicular to pn-junction	$\Theta_{\!\scriptscriptstyle \perp}$	min. typ. max.	19 ° 22 ° 25 °
Threshold current	I _{th}	typ. max.	30 mA 55 mA
Reverse current 3)	I _R		Not designed for reverse operation
TE polarization	P _{TE}	typ.	100:1
Modulation frequency	f	min.	100 MHz
Thermal resistance junction case real	R_{thJC}	typ.	38 K / W

Info: according to OS-IN-2019-028



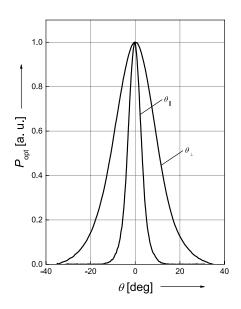
Relative Spectral Emission 6), 7)

$$I_{e,rel} = f(\lambda); P_{opt} = 0 W$$



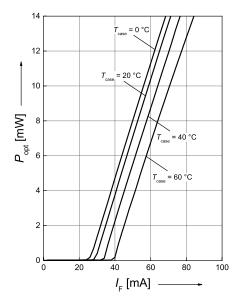
Beam Divergence 6), 7)

$$P_{opt} = f(\Theta)$$



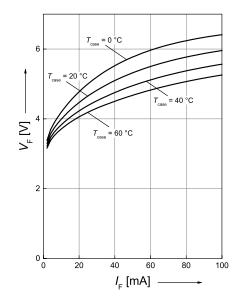
Optical Output Power 6), 7)

$$\mathsf{P}_{\mathsf{opt}} = \mathsf{f}\left(\mathsf{I}_{\mathsf{F}}\right)$$



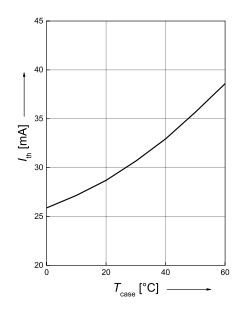
Opt. Power / Forward Voltage 6), 7)

$$V_F = f(I_F)$$

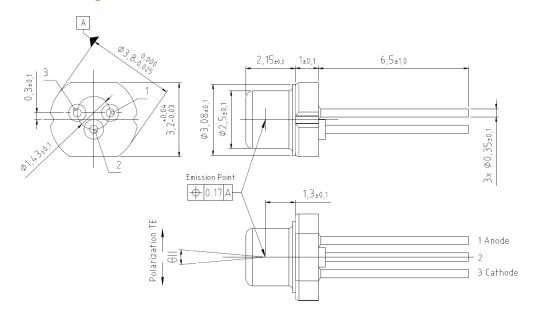


Threshold Current

$$I_{th} = f(T_{C})$$



Dimensional Drawing 8)



C63062-A4180-A1-03

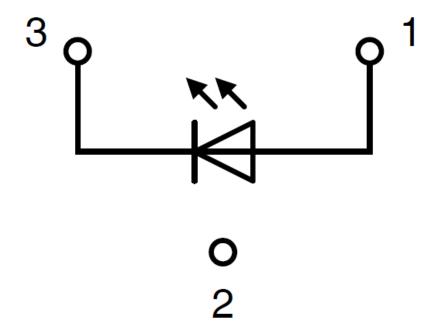
Further Information:

Approximate Weight: 141.0 mg

ESD advice: ATTENTION - Observe Precautions For Handling - Electrostatic Sensitive

Device

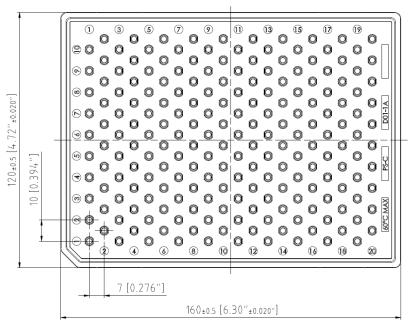
Electrical Internal Circuit



Pin	Description
PIN 1	LD Anode
PIN 2	Case
PIN 3	LD Cathode

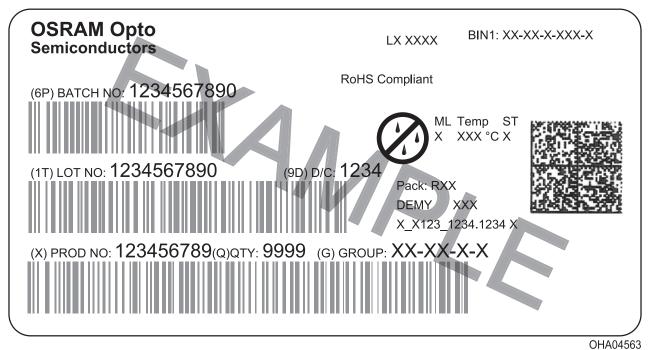
Preliminary datasheet version

Tray 8)
200 pieces per Tray



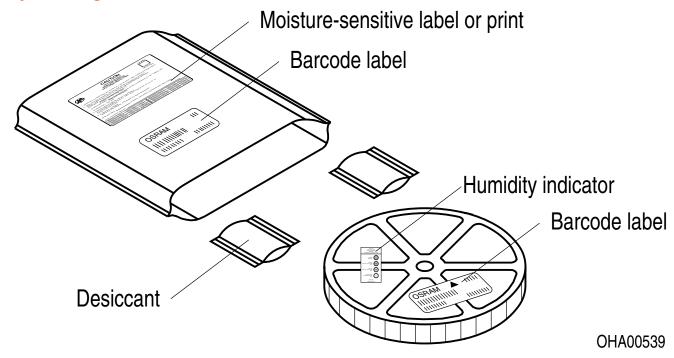
C63062-A4336-B1

Barcode-Product-Label (BPL)

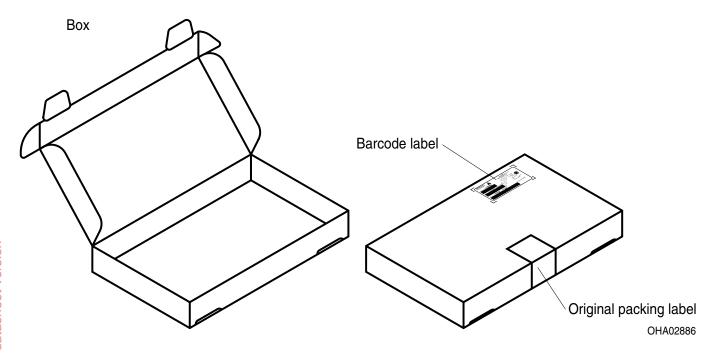




Dry Packing Process and Materials



Schematic Transportation Box 8)





Dimensions of Transportation Box

	insportation box		
Width	Length	Height	
333 ± 5 mm	218 ±5 mm	28 ± 5 mm	



Notes

Depending on the mode of operation, these devices emit highly concentrated visible and non visible light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Important notes of operation for laser diode

a) Electrical operation

OSRAMs laser diodes are designed for maximum performance and reliability. Operating the laser diode above the maximum rating even for very short periods of time can damage the laser diode or reduce its lifetime. The laser diode must be operated with a suitable power supply with minimized electrical noise. The laser diode is very sensitive to electrostatic discharge (ESD). Proper precautions must be taken.

b) Mounting instructions

In order to maintain the lifetime of the laser diode proper heat management is essential. Due to the design of the laser diode heat is dissipated only through the base plate of the diode's body. A proper heat conducting interconnection between the diodes base plate and the heat sink must be maintained.

For further application related information please visit www.osram-os.com/appnotes

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 and IEC 62471.



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For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

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Glossary

- Operating/Forward current: IF is measured with an internal reproducibility of ± 7 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Reverse Operation: Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- Operating/Forward voltage: VF is measured with an internal reproducibility of ± 0.05 V (acc. to GUM with a coverage factor of k = 3).
- Wavelength: λ peak is measured with an internal reproducibility of ± 0.3 nm (acc. to GUM with a coverage factor of k = 3).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Testing temperature:** TA = 25°C (unless otherwise specified)
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



Revision History		
Version	Date	Change
0.2	2019-12-17	Characteristics
0.2	2020-04-17	Characteristics
0.2	2020-04-17	Characteristics



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